## FRED

## Part number

## DSEI12-12AZ

| $\mathrm{V}_{\text {RRM }}$ | $=$ | 1200 V |
| :--- | :--- | ---: |
| $\mathrm{I}_{\mathrm{FAV}}$ | $=$ | 11 A |
| $\mathrm{t}_{\mathrm{rr}}$ | $=$ | 50 ns |

## Single Diode



Backside: cathode


## Features / Advantages:

- Planar passivated chips
- Low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
- Power dissipation within the diode
- Turn-on loss in the commutating switch


## Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-263 (D2Pak-HV)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0


## Terms and Conditions of Usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.
Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.
Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend
to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.


| Package | TO-263 (D2Pak-HV) |  | Ratings |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol | Definition Conditions |  | min. | typ. | max. | Unit |
| $\mathrm{I}_{\text {RMS }}$ | RMS current per terminal |  |  |  | 35 | A |
| Tv, | virtual junction temperature |  | -40 |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {op }}$ | operation temperature |  | -40 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  | -40 |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Weight |  |  |  | 1.5 |  | g |
| $\mathrm{F}_{\mathrm{c}}$ | mounting force with clip |  | 20 |  | 60 | N |
| $\mathbf{d}_{\text {spp/App }}$ <br> $\mathbf{d}_{\text {Spb/Apb }}$ | creepage distance on surface / striking distance through air | terminal to terminal terminal to backside | $\begin{aligned} & 4.2 \\ & 4.7 \end{aligned}$ |  |  | mm $\mathrm{mm}$ |



| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Standard | DSEI12-12AZ | DSEI12-12AZ | Tape \& Reel | 800 | 515338 |

Equivalent Circuits for Simulation *on die level $\quad \mathrm{T}_{\mathrm{v},}=150^{\circ} \mathrm{C}$

| $\mathrm{I} \rightarrow \mathrm{~V}_{0}-\mathrm{R}_{0}$ |  | Fast Diode |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{0 \text { max }}$ | threshold voltage | 1.65 | V |
| $\mathbf{R}_{0 \text { max }}$ | slope resistance * |  | $\mathrm{m} \Omega$ |

Outlines TO-263 (D2Pak-HV)


| Dim. | Millimeter |  | Inches |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | min | max | min | $\max$ |  |  |
| A | 4.06 | 4.83 | 0.160 | 0.190 |  |  |
| A1 | typ. 0.10 |  | typ. 0.004 |  |  |  |
| A2 | 2.41 |  | 0.095 |  |  |  |
| b | 0.51 | 0.99 | 0.020 | 0.039 |  |  |
| b2 | 1.14 | 1.40 | 0.045 | 0.055 |  |  |
| c | 0.40 | 0.74 | 0.016 | 0.029 |  |  |
| c2 | 1.14 | 1.40 | 0.045 | 0.055 |  |  |
| D | 8.38 | 9.40 | 0.330 | 0.370 |  |  |
| D1 | 8.00 | 8.89 | 0.315 | 0.350 |  |  |
| D2 | 2.3 |  | 0.091 |  |  |  |
| E | 9.65 | 10.41 | 0.380 | 0.410 |  |  |
| E1 | 6.22 | 8.50 | 0.245 | 0.335 |  |  |
| e | 2,54 |  | BSC | 0,100 |  | BSC |
| e1 | 4.28 |  | 0.169 |  |  |  |
| H | 14.61 | 15.88 | 0.575 | 0.625 |  |  |
| L | 1.78 | 2.79 | 0.070 | 0.110 |  |  |
| L1 | 1.02 | 1.68 | 0.040 | 0.066 |  |  |
| W | typ. |  | 0.040 | typ. |  | 0.002 |
|  | 0.02 | 0.04 | 0.0008 | 0.002 |  |  |

All dimensions conform with andor within JEDEC standard.


## Fast Diode



Fig. 1 Forward current $I_{F}$ versus $V_{F}$


Fig. 4 Dynamic parameters $Q_{r}, I_{R M}$ versus $T_{V J}$


Fig. 2 Typ. reverse recov. charge $Q_{r}$ versus $-\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$


Fig. 5 Typ. recovery time $\mathrm{t}_{\mathrm{rr}}$ versus $-\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$


Fig. 3 Typ. peak reverse current $\mathrm{I}_{\text {RM }}$ versus $-\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$


Fig. 6 Typ. peak forward voltage $V_{F R}$ and $t_{f r}$ versus $\mathrm{di}_{\mathrm{F}} / \mathrm{dt}$


Fig. 7 Transient thermal impedance junction to case

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Discrete Semiconductor Modules category:

## Click to view products by IXYS manufacturer:

Other Similar products are found below :


